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DOCKET No.: A539WTN

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

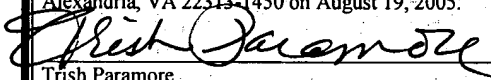
Applicants: Stephen G. Kelly, et al.
Serial No.: 10/085,164
Filed: February 26, 2002
Art Unit: 2814
Examiner: Pham, Hoai V.
For: **ENCAPSULATED DIE PACKAGE WITH IMPROVED PARASITIC AND THERMAL PERFORMANCE**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

CERTIFICATE OF MAILING UNDER 37 C.F.R. 1.8

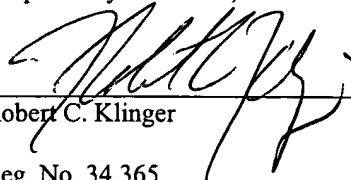
I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on August 19, 2005.


Trish Paramore

RESPONSE TO RESTRICTION REQUIREMENT

In response to the Office Action mailed July 27, 2005, Applicant hereby elects, without traverse, to prosecute in this application Species I, comprising Claims 1-44 drawn to a semiconductor device.

Respectfully submitted,


Robert C. Klinger

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August 19, 2005

Date